

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q95305

Hiroshi YAMADA, et al.

Appln. No.: 10/591,134

Group Art Unit: 2835

Confirmation No.: 7348

Examiner: unknown

Filed: August 30, 2006

For: MODULAR HEAT-RADIATION STRUCTURE AND CONTROLLER INCLUDING
THE STRUCTURE

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination
Filing Receipt Correction
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment For Published Patent Application:

Mitsubishi Electric Corporation

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT
U.S. APPLICATION NO. 10/591,134

Q95305

Verification for the requested correction is indicated on the Assignment filed August 30,
2006.

Respectfully submitted,

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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

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Date: April 20, 2007

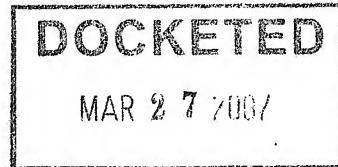


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APPL NO.	FILING OR 371(c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	TOT CLMS	IND CLMS
10/591,134	08/30/2006	2835	900	Q95305	7	1

23373
 SUGHRUE MION, PLLC
 2100 PENNSYLVANIA AVENUE, N.W.
 SUITE 800
 WASHINGTON, DC 20037



CONFIRMATION NO. 7348

FILING RECEIPT



OC00000022868561

Date Mailed: 03/26/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Hiroshi Yamada, Tokyo, JAPAN;
 Tomonori Abe, Tokyo, JAPAN;
 Keiichi Takikoshi, Tokyo, JAPAN;

Assignment For Published Patent Application: Mitsubishi Electric Corporation

Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/03811 03/18/2004

Foreign Applications

If Required, Foreign Filing License Granted: 03/12/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/591,134**

Projected Publication Date: 06/21/2007

Non-Publication Request: No

Early Publication Request: No

Title

Modular heat-radiation structure and controller including the structure

Preliminary Class

361

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

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Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at <http://www.uspto.gov/web/offices/pac/doc/general/index.html>.

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Assignment

Whereas, We, **Hiroshi YAMADA, Tomonori ABE and Keiichi TAKIKOSHI** of c/o Mitsubishi Electric Corporation, 7-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310, JAPAN, hereinafter called assignor, have invented certain improvements in

**MODULAR HEAT-RADIATION STRUCTURE AND CONTROLLER
INCLUDING THE STRUCTURE** and executed an application for Letters Patent of the United States of America therefor on _____; and

Whereas, **MITSUBISHI ELECTRIC CORPORATION**, 7-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310, JAPAN, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

We, the above named assignor, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses (Application number _____ and Confirmation number _____, filed _____) the application number and filing date of said application when known.

Date: July 13, 2006 **Hiroshi YAMADA**

s/Hiroshi YAMADA

Date: July 13, 2006 **Tomonori Abe**

s/Tomonori ABE

Date: July 13, 2006 **Keiichi Takikoshi**

s/Keiichi TAKIKOSHI